## SY58606U



# 4.25Gbps Precision, 1:2 CML Fanout Buffer with Internal Termination and Fail Safe Input

#### **General Description**

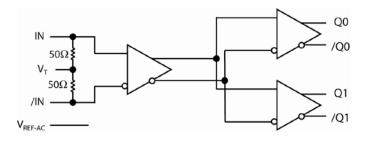
The SY58606U is a 2.5/3.3V, high-speed, fully differential 1:2 CML fanout buffer optimized to provide two identical output copies with less than 15ps of skew and 100fs<sub>RMS</sub> of typical additive phase jitter. The SY58606U can process clock signals as fast as 3GHz or data patterns up to 4.25Gbps.

The differential input includes Micrel's unique, 3-pin input termination architecture that interfaces to LVPECL, LVDS or CML differential signals, (AC- or DC-coupled) as small as 100mV (200mV<sub>pp</sub>) without any level-shifting or termination resistor networks in the signal path. For AC-coupled input interface applications, an integrated voltage reference (V<sub>REF-AC</sub>) is provided to bias the V<sub>T</sub> pin. The outputs are 400mV CML, with extremely fast rise/fall times guaranteed to be less than 85ps.

The SY58606U operates from a 2.5V ±5% supply or 3.3V ±10% supply and is guaranteed over the full industrial temperature range (-40°C to +85°C). For applications that require LVPECL or LVDS outputs, consider Micrel's SY58607U and SY58608U, 1:2 fanout buffers with 800mV and 325mV output swings respectively. The SY58606U is part of Micrel's high-speed, Precision Edge® product line.

Datasheets and support documentation can be found on Micrel's web site at: <a href="https://www.micrel.com">www.micrel.com</a>.

## **Functional Block Diagram**



#### **Features**

- Precision 1:2, 400mV CML fanout buffer
- Guaranteed AC performance over temperature and voltage:
  - DC-to > 4.25Gbps throughput
  - <320ps propagation delay (IN-to-Q)</li>
  - <15ps within-device skew</p>
  - <85ps rise/fall times</p>
- Fail Safe Input
  - Prevents outputs from oscillating when input is invalid
- Ultra-low jitter design
  - 100fs<sub>RMS</sub> typical additive jitter
- High-speed CML outputs
- 2.5V ±5% or 3.3V ±10% power supply operation
- Industrial temperature range: -40°C to +85°C
- Available in 16-pin (3mm x 3mm) QFN package

## **Applications**

- Data Distribution: OC-48, OC-48+FEC, XAUI
- SONET clock and data distribution
- Fibre Channel clock and data distribution
- Gigabit Ethernet clock and data distribution

#### **Markets**

- Storage
- ATE
- Test and measurement
- Enterprise networking equipment
- High-end servers
- Access
- Metro area network equipment

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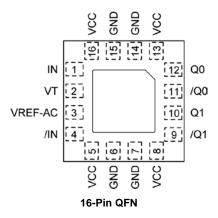
## Ordering Information<sup>(1)</sup>

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY58606UMG	QFN-16	Industrial	606U with Pb-Free bar-line indicator	NiPdAu Pb-Free
SY58606UMGTR <sup>(2)</sup>	QFN-16	Industrial	606U with Pb-Free bar-line indicator	NiPdAu Pb-Free

#### Notes:

Contact factory for die availability. Dice are guaranteed at  $T_A$  = 25°C, DC Electricals only. Tape and Reel.

## **Pin Configuration**



## **Pin Description**

Pin Number	Pin Name	Pin Function
1, 4	IN, /IN	Differential Input: This input pair is the differential signal input to the device. Input accepts DC-coupled differential signals as small as $100\text{mV}$ ( $200\text{mV}_{PP}$ ). Each pin of this pair internally terminates with $50\Omega$ to the VT pin. If the input swing falls below a certain threshold (typical $30\text{mV}$ ), the Fail Safe Input (FSI) feature will guarantee a stable output by latching the output to its last valid state. See "Input Interface Applications" section.
2	VT	Input Termination Center-Tap: Each side of the differential input pair terminates to VT pin. This pin provides a center-tap to a termination network for maximum interface flexibility. See "Input Interface Applications" section.
3	VREF-AC	Reference Voltage: This output biases to $V_{CC}$ –1.2V. It is used for AC-coupling inputs IN and /IN. Connect VREF-AC directly to the VT pin. Bypass with 0.01 $\mu$ F low ESR capacitor to VCC. Maximum sink/source current is $\pm 1.5$ mA. See "Input Interface Applications" section.
5, 8,13, 16	VCC	Positive Power Supply: Bypass with 0.1uF//0.01uF low ESR capacitors as close to the V <sub>CC</sub> pins as possible.
6, 7, 14, 15	GND,	Ground: Exposed pad must be connected to a ground plane that is the same potential as
0, 7, 14, 15	Exposed Pad	the ground pins.
9, 10	/Q1, Q1	CML Differential Output Pairs: Differential buffered copies of the input signal. The output swing is typically 400mV. Unused output pair may be left floating with no impact on jitter.
11, 12	/Q0, Q0	See "CML Output Termination" section.

## **Absolute Maximum Ratings**(3)

Supply Voltage (V <sub>CC</sub> )0.5V to +4.0V
Input Voltage (V <sub>IN</sub> )
CML Output Voltage (V <sub>OUT</sub> )V <sub>CC</sub> -1.0V to V <sub>CC</sub> +0.5V
Current (V <sub>T</sub> )
Source or sink on V <sub>T</sub> pin±100mA
Input Current
Source or sink Current on (IN, /IN) ±50mA
Current (V <sub>REF</sub> )
Source or sink current on V <sub>REF-AC</sub> <sup>(6)</sup> ±1.5mA
Maximum operating Junction Temperature125°C
Lead Temperature (soldering, 20sec.)260°C
Storage Temperature (T <sub>s</sub> )65°C to +150°C

## Operating Ratings<sup>(4)</sup>

Supply Voltage (V <sub>IN</sub> ) Ambient Temperature (T <sub>A</sub> ) Package Thermal Resistance <sup>(5)</sup>	
rackage intermal Resistance	
QFN	
Still-air ( $\theta_{JA}$ )	60°C/W
Junction-to-board (w 🔊)	33°C/W

## DC Electrical Characteristics<sup>(7)</sup>

 $T_A = -40$ °C to +85°C, unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Max	Units
V <sub>CC</sub>	Power Supply Voltage Range		2.375	2.5	2.625	V
			3.0	3.3	3.6	
Icc	Power Supply Current	No load, max. V <sub>CC</sub>		60	77	mA
R <sub>DIFF_IN</sub>	Differential Input Resistance (IN-to-/IN)		90	100	110	Ω
V <sub>IH</sub>	Input HIGH Voltage (IN, /IN)	IN, /IN, Note 9	V <sub>CC</sub> -1.6		V <sub>cc</sub>	V
V <sub>IL</sub>	Input LOW Voltage (IN, /IN)	IN, /IN	0		V <sub>IH</sub> -0.1	V
$V_{IN}$	Input Voltage Swing (IN, /IN)	See Figure 5, Note 8	0.1		1.7	V
$V_{DIFF\_IN}$	Differential Input Voltage Swing ( IN - /IN )	See Figure 6	0.2			V
V <sub>IN_FSI</sub>	Input Voltage Threshold that Triggers FSI			30	100	mV
V <sub>REF-AC</sub>	Output Reference Voltage		V <sub>CC</sub> -1.3	V <sub>CC</sub> -1.2	V <sub>CC</sub> -1.1	V
$V_{T\_IN}$	Voltage from Input to V <sub>T</sub>				1.28	V

#### Notes

- 3. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.
- 4. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
- Package thermal resistance assumes exposed pad is soldered (or equivalent) to the device's most negative potential on the PCB. ψ<sub>JB</sub> and θ<sub>JA</sub> values are determined for a 4-layer board in still-air number, unless otherwise stated.
- 6. Due to the limited drive capability, use for input of the same package only.
- 7. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.
- 8.  $V_{IN}$  (max) is specified when  $V_T$  is floating.
- 9. V<sub>IH</sub> (min) not lower than 1.2V.

## CML Outputs DC Electrical Characteristics<sup>(10)</sup>

 $V_{CC}$  = +2.5V ±5% or +3.3V ±10%,  $R_L$  = 100 $\Omega$  across the outputs;  $T_A$  = -40°C to +85°C, unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Max	Units
V <sub>OH</sub>	Output HIGH Voltage	$R_L = 50\Omega$ to $V_{CC}$	V <sub>CC</sub> -0.020	V <sub>CC</sub> -0.010	$V_{CC}$	V
V <sub>OUT</sub>	Output Voltage Swing	See Figure 5	325	400		mV
$V_{DIFF\_OUT}$	Differential Output Voltage Swing	See Figure 6	650	800		mV
R <sub>OUT</sub>	Output Source Impedance		45	50	55	Ω

#### Note:

#### **AC Electrical Characteristics**

 $V_{CC}$  = +2.5V ±5% or +3.3V ±10%,  $R_L$  = 100 $\Omega$  across the outputs, Input  $t_r/t_f$ :  $\leq$ 300ps;  $T_A$  = -40°C to +85°C, unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Max	Units
f <sub>MAX</sub>	Maximum Frequency	NRZ Data	4.25			Gbps
		V <sub>OUT</sub> > 200mV Clock	2.5	3.0		GHz
t <sub>PD</sub>	Propagation Delay IN-to-Q	V <sub>IN</sub> : 100mV-200mV	150	270	400	ps
		V <sub>IN</sub> : 200mV-800mV	120	220	320	ps
t <sub>Skew</sub>	Within Device Skew	Note 11		3	15	ps
	Part-to-Part Skew	Note 12			100	ps
t <sub>Jitter</sub>	Additive Jitter	Carrier = 622MHz Integration Range: 12kHz – 20MHz		100		fs <sub>RMS</sub>
t <sub>R</sub> t <sub>F</sub>	Output Rise/Fall Time (20% to 80%)	At full output swing.	30	50	85	ps
	Duty Cycle	Differential I/O	47		53	%

#### Notes:

<sup>10.</sup> The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

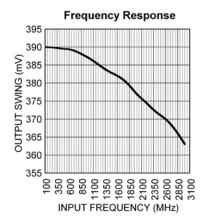
<sup>11.</sup> Within device skew is measured between two different outputs under identical input transitions.

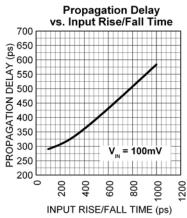
<sup>12.</sup> Part-to-part skew is defined for two parts with identical power supply voltages at the same temperature and no skew at the edges at the respective inputs.

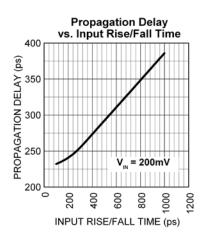
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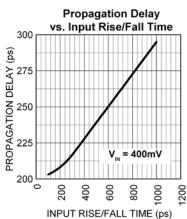
## **Typical Characteristics**

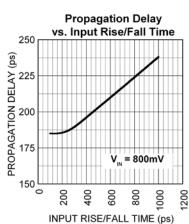
 $V_{CC}$  = 3.3V, GND = 0V,  $V_{IN}$  = 100mV,  $R_L$  = 100 $\Omega$  across the outputs,  $T_A$  = 25°C, unless otherwise stated.







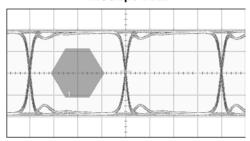




#### **Functional Characteristics**

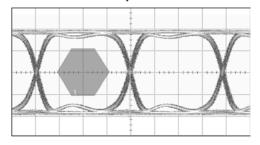
 $V_{CC}$  = 2.5V, GND = 0V,  $V_{IN}$  = 325mV, Data Pattern:  $2^{23}$ -1,  $R_L$  = 100 $\Omega$  across the outputs,  $T_A$  = 25°C, unless otherwise stated.

### 1.25Gbps Data



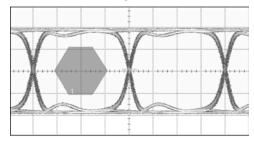
TIME (200ps/div.)

#### 3.2Gbps Data



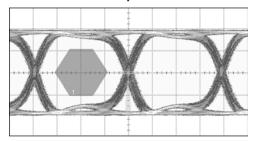
TIME (80ps/div.)

#### 2.5Gbps Data



TIME (100ps/div.)

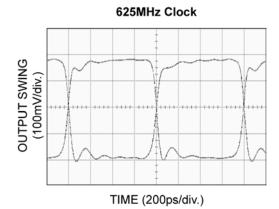
#### 4.25Gbps Data

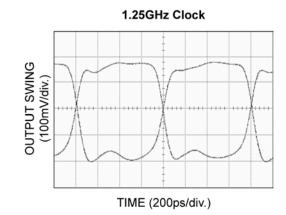


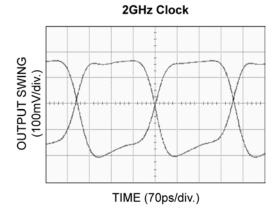
TIME (60ps/div.)

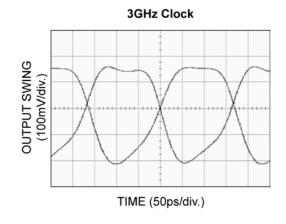
#### **Functional Characteristics (continued)**

 $V_{CC}$  = 2.5V, GND = 0V,  $V_{IN}$  = 325mV,  $R_L$  = 100 $\Omega$  across the outputs,  $T_A$  = 25°C, unless otherwise stated.



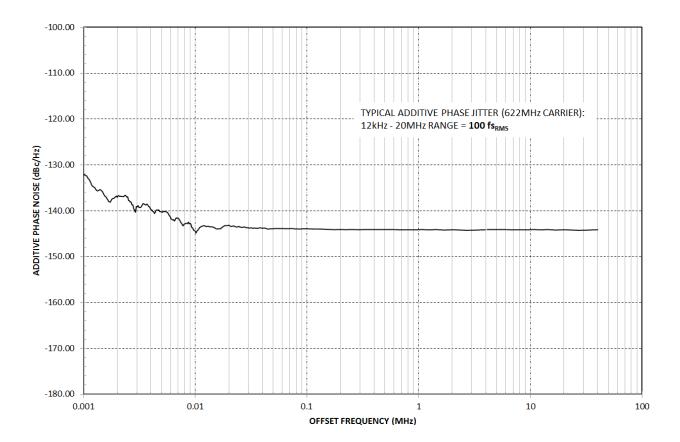






## **Additive Phase Noise Plot**

 $V_{CC} = +3.3V, T_A = 25^{\circ}C$ 



## **Functional Description**

#### Fail-Safe Input (FSI)

The input includes a special fail-safe circuit to sense the amplitude of the input signal and to latch the outputs when there is no input signal present, or when the amplitude of the input signal drops sufficiently  $100 \text{mV}_{PK}$  (200 mV<sub>PP</sub>), typically  $30 \text{mV}_{PK}$ . Maximum frequency of SY58606U is limited by the FSI function.

#### **Input Clock Failure Case**

If the input clock fails to a floating, static, or extremely low signal swing, then the FSI function will eliminate a metastable condition and guarantee a stable output. No ringing and no undetermined state will occur at the output under these conditions.

Note that the FSI function will not prevent duty cycle distortion in case of a slowly deteriorating (but still toggling) input signal. Due to the FSI function, the propagation delay will depend on rise and fall time of the input signal and on its amplitude. Refer to "Typical Characteristics" for detailed information.

## **Timing Diagrams**

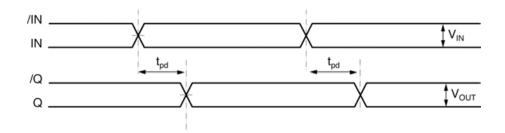


Figure 1. Propagation Delay

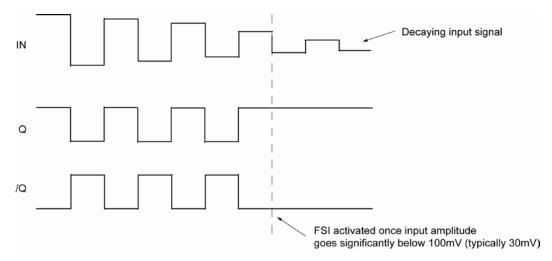


Figure 2 . Fail Safe Feature

## **Input and Output Stage**

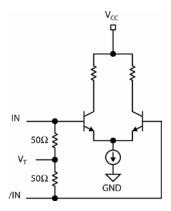


Figure 3. Simplified Differential Input Buffer

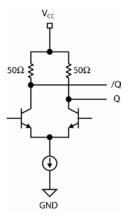


Figure 4. Simplified CML Output Buffer

## **Single-Ended and Differential Swings**



Figure 5. Single-Ended Swing

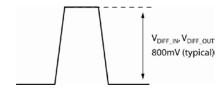


Figure 6. Differential Swing

## **Input Interface Applications**

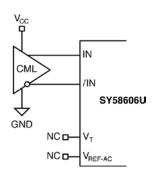


Figure 7. CML Interface (DC-Coupled) Option: May connect  $V_T$  to  $V_{CC}$ 

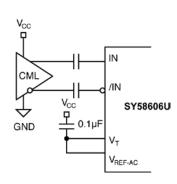


Figure 8. CML Interface (AC-Coupled)

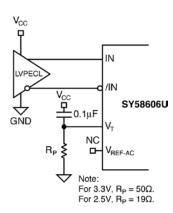


Figure 9. LVPECL Interface (DC-Coupled)

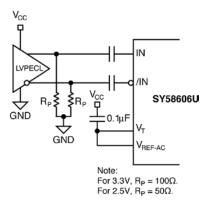


Figure 10. LVPECL Interface (A C-Coupled)

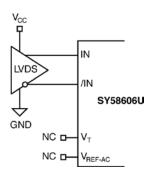
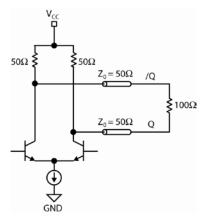


Figure 11. LVDS Interface

## **CML Output Termination**



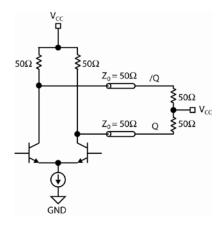


Figure 12. CML DC-Coupled Termination

Figure 13. CML DC-Coupled Termination

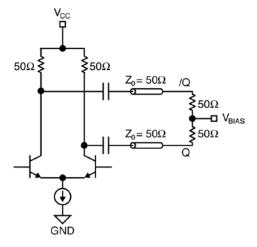
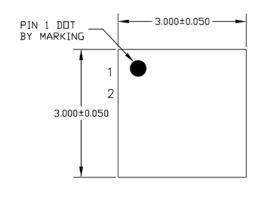


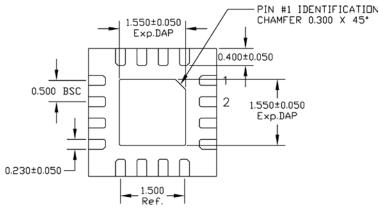
Figure 14. CML AC-Coupled Termination

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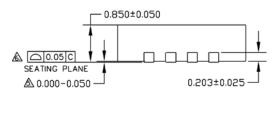
## **Package Information**



TOP VIEW



BOTTOM VIEW



SIDE VIEW

NOTE:

ALL DIMENSIONS ARE IN MILLIMETERS.

MAX. PACKAGE WARPAGE IS 0.05 mm.

MAXIMUM ALLIUWABE BURRS IS 0.076 mm IN ALL DIRECTIONS.

PIN #1 ID ON TOP WILL BE LASER/INK MARKED.

APPLIED ONLY FOR TERMINALS.

APPLIED FOR EXPOSED PAD AND TERMINALS.

16-Pin QFN

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